Silicon Vertex Tracker for SuperB

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General Overview of Silicon Vertex Tracker (SVT)

- Physics requirements
- SVT Layers 1-5
- Layer0 setup

2 Options for layer0

- Striplets
- Hybrid Pixels
- MAPS

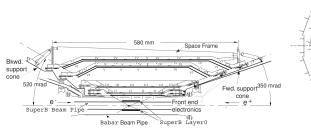


Physics requirements

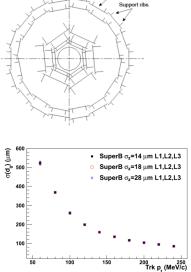
The SuperB SVT design is based on the BaBar vertex detector layout with an additional innermost layer closer to the IP (Layer0).

- SVT together with drift chamber (DCH) and magnet provide track and vertex reconsturction.
- e For less energetic particles SVT must provide the complete track information.
- **③** SVT must provide the same precision of time dependent CP violation as BaBar detector with boost reduced from $\beta\gamma = 0.55$ to $\beta\gamma = 0.28$
 - $50 80 \mu m$ for exclusively reconstructed modes.
 - $100 150 \mu m$ for inclusively reconstructed modes.

SVT Layers 1-5



- Five layers(1-5) of double-sided silicon strip detectors.
- Radial span 3 15 cm.



Detector wafer

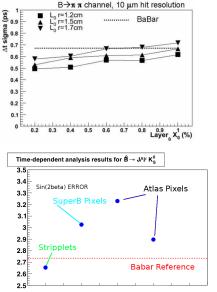
Layer0

To meet the physics requirements mentioned for SuperB an additional 6th layer was introduced (Layer0). Reguirements for Layer0:

- Radius about 1.5 cm
- High granuality.
- Iow material budget.

Aspects that are being considered in projecting Layer0:

- Background:
 - $e^+e^- > e^+e^+e^-e^-$.
 - Bhabha scattering.
 - Touschek.
 - two-photon events.
- Sensor occupancy.
- 8 Radiation hardness.

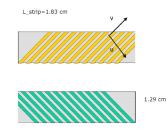


List of options

- Double-sided silicon strip detector (Striplets).
- 2 Pixel detectors:
 - Hybrid pixels.
 - MAPS.

Striplets

- $200\mu m$ thick, with $50\mu m$ readout pitch.
- Rotated by $\pm 45^{\circ}$.
- Chip with 128 analog channels and 132 *ns* time window.
- Signal to Noise ratio: 26 to 1.
- Material budget: 0.55%X₀
- Cluster rate: 6.37*MHz* cm⁻²

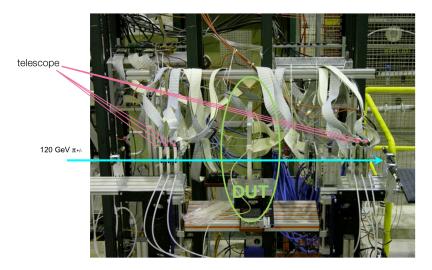


P side

N side

9.7 cm

SVT Test Beam



 $\mathsf{DUT} = \mathsf{Device} \ \mathsf{Under} \ \mathsf{Test.}$

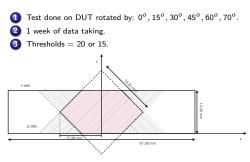
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Striplets

45000

SVT Test Beam

Work done by: Laura Fabbri (INFN Bologna)



8.773e-05 Mean 40000F RMS 0.004272 γ^2/ndf 5330/97 35000 4 634e+04 + 1 418e+02 -1.577e-05 ± 3.537e-06 30000F 0.001453 ± 0.000003 25000F 20000F 15000F 10000F 5000E -0.05 -0.04 -0.03 -0.02 -0.01 0 0.01 0.02 0.03 0.04 0.05 spXPos - intXPos (cm) residual Y resid v Entries 196150 40000 Mean -6.854e-05 RMS 0.004642 35000 $r^2/nd!$ 5930 / 97 4 376+04 + 1 348+03 30000E -5.175e-05 ± 3.729e-06 0.001543 ± 0.000003 25000 20000F 15000E 10000 5000 -0.05 -0.04 -0.03 -0.02 -0.01 0 0.01 0.02 0.03 0.04 0.05 spXPos - intXPos (cm)

residual X

resid x

196150

Entries

Procedure:

- Alignment done by minimizing residuals, ۲ on telescope and DUT.
- Cut on the residual: $56\mu m$ and fiducial cut.

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1.5 spXPos (cm)



 Inactive strips not taken into account in the analysis

striplets space point (global coordinates after alignment)

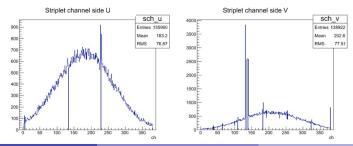
(cu) sodYpas

> 0.4 0.2

> > oF

-0.2 -0.4

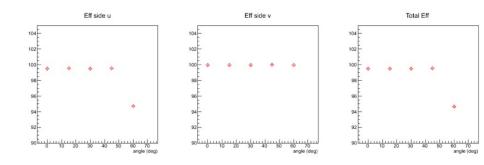
Telescope acceptance



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Efficiency vs angle



- Pixels: 50 x 50 μm^2 pitch.
- 200µ*m* thick.
- Front end chip optimised to work with 100*MHz* cm^{-2} .
- Organised in Mega Pixels (16 Pixels).
- Data-push readout featuring on-pixel data sparsification and time-stamp.
- Gain = $42mV fC^{-1}$.



Hybrid Pixels Test Beam Notes

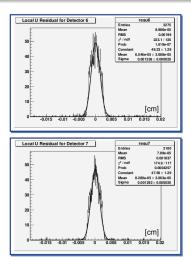
Work done by:

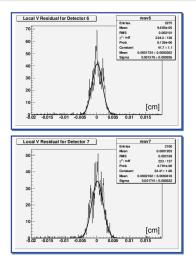
A.Lusiani, M.Chrzaszcz, Nicola Neri, Benjamin Oberhof, Antonio Paladino.

- Several thresholds, reference threshold 1/4 of a m.i.p. at normal incidence.
- Data took with 3 chips: 12, 53, 55.
- DUT rotated around at 0°, 15°, 30°, 45°, 60°, 70°.
- 128 pixels along x (horizontal, u-axis), 32 pixels along y (vertical, v -axis).
- approximately parallel tracks, high momentum, negligible multiple scattering.

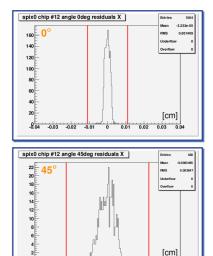
Hybrid Pixels Test Beam Results

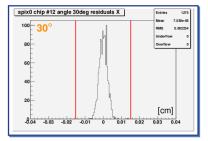
Typical resolution: $20\mu m$.

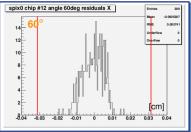




Angular dependence of the residual







-0.02

-0.01

-8.04 -0.03

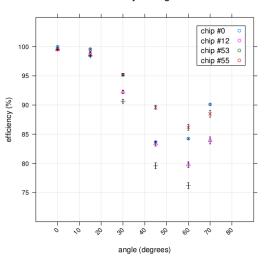
[cm]

0.03

0.02

0.04

Hybrid Pixels: Test Beam

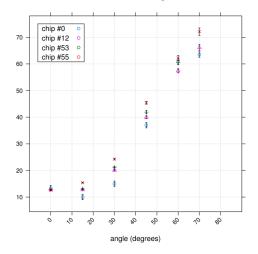


efficiency vs. angle

- To cross check our results, TOY MC was written.
- Good agreement with data.

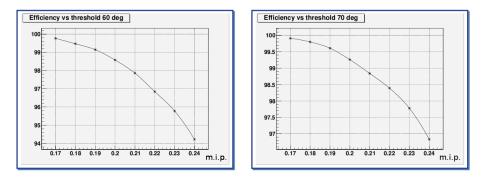
Hybrid Pixels Test Beam Results

- To cross check our results, TOY MC was written.
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x resolution vs. angle

Threshold Simulations

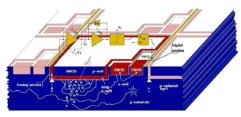


Conclusion

The next Test Beam will be done with lower threshold(0.17 - 0.18 m.i.p).

Monolithic Active PixelS

- Newer, more challenging.
- Pixels: 50 x 50 μm^2 pitch, 50 μm thickness.
- Active cooling is needed (2 *W* cm⁻²).
- Implemented in Deep n-well.
- Full signal processing chain: large preamplifier, shaper, discriminator, in-pixel logic.
- No TestBeam results yet. MC and lab results:
 - Efficiency:98%.
 - 100*ns* timestamp.
- Much more R&D to be done.



The R&D work on the SuperB SVT is well advanced. Crucial issues for Layer0:

- Striplets most ready and working solution for the beginning of SuperB data-taking.
- *R*&*D* still needed.

Outcome of work on Hybrid Pixels:

- Study of the residuals and angular dependence.
- Smaller threshold planned for next simulations.

In the TDR(Feb 2012) both options will be presented. Final decision will follow after.